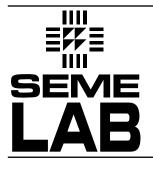
TetraFET

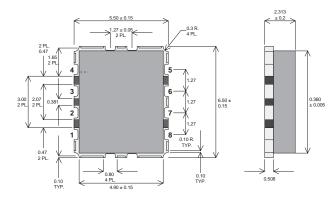
D2230UK



ROHS COMPLIANT METAL GATE RF SILICON FET

MECHANICAL DATA

Dimensions in mm.



F-0127 PACKAGE

PIN 1 - SOURCE
PIN 2 – DRAIN
PIN 3 – DRAIN
PIN 4 - SOURCE

HAGE PIN 5 – SOURCE PIN 6 – GATE PIN 7 – GATE PIN 8 – SOURCE

Ceramic Material: Alumina. Parts can also be supplied with AIN or BeO for improved thermal resistance. Contact Semelab for details.

GOLD METALLISED MULTI-PURPOSE SILICON DMOS RF FET 5W – 12.5V – 1GHz SINGLE ENDED

FEATURES

- SIMPLIFIED AMPLIFIER DESIGN
- SUITABLE FOR BROAD BAND APPLICATIONS
- VERY LOW C_{rss}
- SIMPLE BIAS CIRCUITS
- LOW NOISE
- HIGH GAIN 10 dB MINIMUM

APPLICATIONS

• HF/VHF/UHF COMMUNICATIONS from 1 MHz to 2 GHz

ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C unless otherwise stated)

Power Dissipation	17.5W
Drain – Source Breakdown Voltage	40V
Gate – Source Breakdown Voltage	±20V
Drain Current	4A
Storage Temperature	–65 to 150°C
Maximum Operating Junction Temperature	200°C
	Drain – Source Breakdown Voltage Gate – Source Breakdown Voltage Drain Current Storage Temperature

Semelab Plc reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by Semelab is believed to be both accurate and reliable at the time of going to press. However Semelab assumes no responsibility for any errors or omissions discovered in its use. Semelab encourages customers to verify that datasheets are current before placing orders.



ELECTRICAL CHARACTERISTICS (T_{case} = 25°C unless otherwise stated)

	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0$	I _D = 10mA	40			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 12.5V	V _{GS} = 0			2	mA
I _{GSS}	Gate Leakage Current	V _{GS} = 20V	$V_{DS} = 0$			1	μΑ
V _{GS(th)}	Gate Threshold Voltage*	I _D = 10mA	$V_{DS} = V_{GS}$	0.5		7	V
9 _{fs}	Forward Transconductance*	V _{DS} = 10V	I _D = 0.4A	0.36			S
G _{PS}	Common Source Power Gain	P _O = 5W		10			dB
η	Drain Efficiency	V _{DS} = 12.5V	I _{DQ} = 0.2A	40			%
VSWR	Load Mismatch Tolerance	f = 1GHz		20:1			—
C _{iss}	Input Capacitance	$V_{DS} = 0V V_{C}$	$_{SS} = -5V$ f = 1MHz			24	pF
C _{oss}	Output Capacitance	V _{DS} = 12.5V V _G	$_{\rm SS} = 0$ f = 1MHz			20	pF
C _{rss}	Reverse Transfer Capacitance	V _{DS} = 12.5V V _G	$_{\rm SS} = 0$ f = 1MHz			2	pF

* Pulse Test: Pulse Duration = 300 μs , Duty Cycle $\leq 2\%$

THERMAL DATA

R _{THi-case} Thermal Resistance Junction – Case	Max. 6°C / W
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